GreenPAK 2[™] Logic Gates



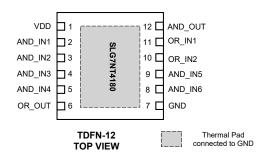
General Description

Renesas GreenPAK 2 SLG7NT4180 is a low power and small form device. The SoC is housed in a 2.5mm x 2.5mm TDFN package which is optimal for using with small devices.

Features

- Low Power Consumption
- 3.3V Supply Voltage
- RoHS Compliant / Halogen-Free
- Pb-Free TDFN-12 Package

Pin Configuration



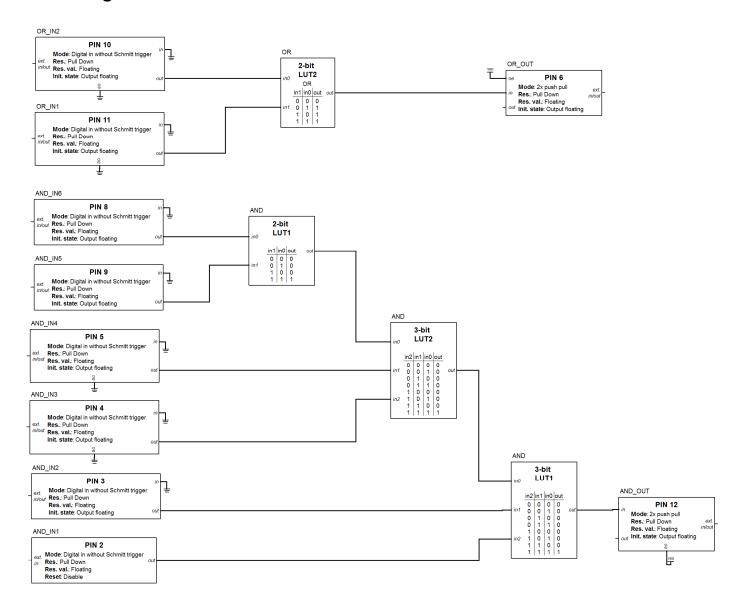
Output Summary

• 2 Outputs - Push Pull





Block Diagram







Pin Configuration

Pin#	Pin Name	Type	Pin Description
1	VDD	PWR	Supply Voltage
2	AND_IN1	Input	Digital Input
3	AND_IN2	Input	Digital Input
4	AND_IN3	Input	Digital Input
5	AND_IN4	Input	Digital Input
6	OR_OUT	Output	Push Pull
7	GND	GND	Ground
8	AND_IN6	Input	Digital Input
9	AND_IN5	Input	Digital Input
10	OR_IN0	Input	Digital Input
11	OR_IN1	Input	Digital Input
12	AND_OUT	Output	Push Pull
Exposed	Exposed Bottom Pad	GND	Ground
Bottom Pad			

Ordering Information

Part Number	Package Type
SLG7NT4180V	V = TDFN-12
SLG7NT4180VTR	VTR = TDFN-12 - Tape and Reel (3k units)



Absolute Maximum Conditions

Parameter	Min.	Max.	Unit
V _{HIGH} to GND	-0.3	7	V
Voltage at input pins	-0.3	7	V
Current at input pin	-1.0	1.0	mA
Storage temperature range	-65	150	°C
Junction temperature		150	°C

Electrical Characteristics

(@ 25°C, unless otherwise stated)

Symbol	Parameter	Condition/Note	Min.	Тур.	Max.	Unit
V_{DD}	Supply Voltage		3.0	3.3	3.6	V
ΙQ	Quiescent Current	Static inputs and outputs		1		μΑ
TA	Operating Temperature		-40	25	85	°C
lι	Input Leakage Current	Leakage Current Inputs or outputs in High impedance state	-100		100	nA
ViH	HIGH-Level Input Voltage	Logic Input	1.8			V
VIL	LOW-Level Input Voltage	Logic Input			1.10	V
V _{OH}	HIGH-Level Output Voltage	Push-Pull, I _{OH} = 3mA	2.6			
Vol	LOW-Level Output Voltage	Push-Pull, I _{OL} = 3mA			0.32	V
Vo	Maximal Voltage Applied to any PIN in High-Impedance State				VDD	٧
loL	LOW-Level Output Current	Push-Pull, VOL = 0.4V, 1X Drive	3.6			mA
Tsu	Start up Time	After VDD reaches 1.6V level		7		ms

Logic Gates



SLG7NT4180 Functionality Waveform

D0 – PIN2 (AND_IN1)

D1 - PIN3 (AND_IN2)

D2 – PIN4 (AND_IN3)

D3 - PIN5 (AND_IN4)

D4 – PIN9 (AND_IN5)

D5 – PIN8 (AND_IN6)

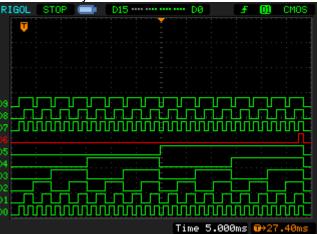
D6 - PIN12 (AND OUT)

D7 – PIN10 (OR_IN2)

D8 - PIN11 (OR_IN1)

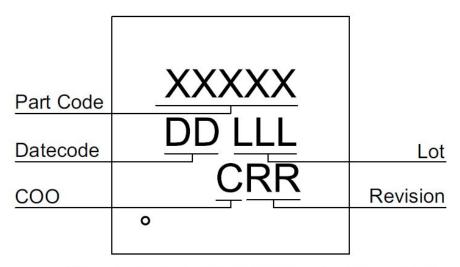
D9 - PIN6 (OR_OUT)







Package Top Marking



XXXXX - Part ID Field: identifies the specific device configuration

DD — Date Code Field: Coded date of manufacture

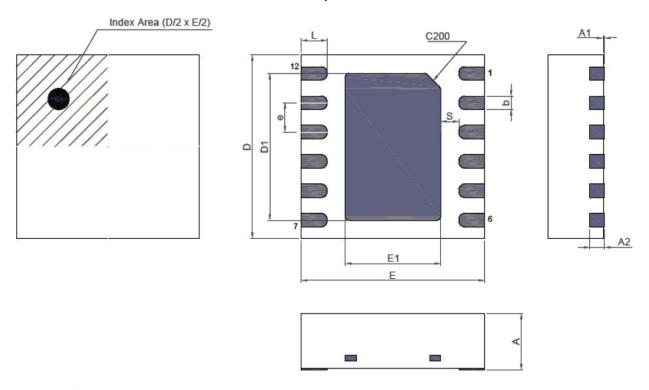
LLL – Lot Code: Designates Lot #
C – COO: Specifies Country of Origin
RR – Revision Code: Device Revision

Datasheet Revision	Programming Code Number	Part Code	Revision	Date
1.01	02	4180V	AA	02/25/2022



Package Drawing and Dimensions

12 Lead TDFN Package JEDEC MO-252, Variation 2525E



Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
Α	0.70	0.75	0.80	D1	1.95	2.00	2.05
A1	0.005	-	0.060	E1	1.25	1.30	1.35
A2	0.15	0.20	0.25	е	0.40 BSC		
b	0.13	0.18	0.23	L	0.30	0.35	0.40
D	2.45	2.50	2.55	S	0.18		-
E	2.45	2.50	2.55				

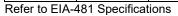


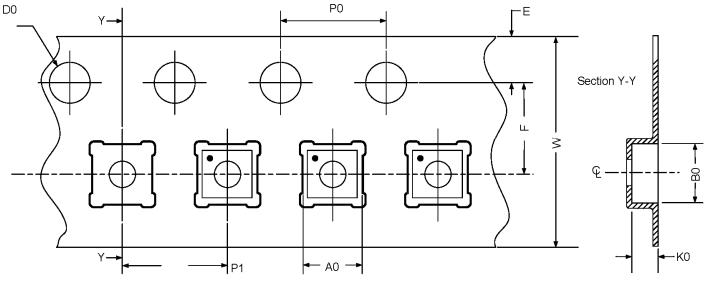
Tape and Reel Specification

	# of	Nominal	Max Units		Reel &	Trailer A		Leader B		Pocket (mm)	
Package Type	Pins	Package Size (mm)	per reel	per box	Hub Size (mm)	Pockets	Length (mm)	Pockets	Length (mm)	Width	Pitch
TDFN 12L 2.5x2.5mm 0.4P Green	12	2.5x2.5x0.75	3000	3000	178/60	42	168	42	168	8	4

Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length (mm)	Pocket BTM Width (mm)	Pocket Depth (mm)	Index Hole Pitch (mm)	Pocket Pitch (mm)	Index Hole Diameter (mm)	Index Hole to Tape Edge (mm)	Index Hole to Pocket Center (mm)	Tape Width (mm)
	Α0	В0	K0	P0	P1	D0	E	F	w
TDFN 12L 2.5x2.5mm 0.4P Green	2.75	2.75	1.05	4	4	1.55	1.75	3.5	8





Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of $4.6875 \, \text{mm}^3$ (nominal). More information can be found at <u>www.jedec.org</u>.

SLG7NT4180





Datasheet Revision History

Date	Version	Change
04/15/2013	0.10	New design
04/16/2013	0.11	OR Gate is added
05/06/2013	0.12	Updated Device Revision Table
06/05/2013	1.0	Production release
02/25/2022	1.01	Updated Company name and logo

Logic Gates



Silego Website & Support

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For more information regarding Silego Green products, please visit:

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